TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VCX162244FT

Low-Voltage 16-Bit Bus Buffer with 3.6-V Tolerant Inputs and Outputs

The TC74VCX162244FT is a high-performance CMOS 16-bit bus buffer. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to 3.6 V.

This device is non-inverting 3-state buffer having four active-low output enables. It can be used as four 4-bit buffers two 8-bit buffers or one 16-bit buffer. When the \overrightarrow{OE} input is high, the outputs are in a high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

The 26- Ω series resistor helps reducing output overshoot and undershoot without external resistor.

All inputs are equipped with protection circuits against static discharge.

Features

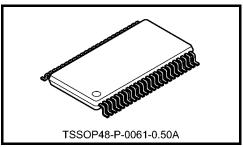
- $26-\Omega$ series resistors on outputs.
- Low-voltage operation: $V_{CC} = 1.8$ to 3.6 V
- High-speed operation $: t_{pd} = 3.3 \text{ ns} (\text{max}) (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
 - $: t_{pd} = 3.8 \text{ ns} (\text{max}) (V_{CC} = 2.3 \text{ to } 2.7 \text{ V})$

$$t_{pd} = 5.7 \text{ ns} \text{ (max)} (V_{CC} = 1.8 \text{ V})$$

- Output current: $I_{OH}/I_{OL} = \pm 12 \text{ mA} \text{ (min)} (V_{CC} = 3.0 \text{ V})$
 - $: I_{OH}/I_{OL} = \pm 8 \text{ mA (min)} (V_{CC} = 2.3 \text{ V})$
 - : $I_{OH}/I_{OL} = \pm 4 \text{ mA} \text{ (min)} (V_{CC} = 1.8 \text{ V})$
- Latch-up performance: -300 mA
- ESD performance: Machine model $\geq \pm 200$ V

Human body model $\geq \pm 2000 \text{ V}$

- Package: TSSOP
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs





Pin Assignment (top view)

	1		l	
10E	1	\bigcirc	48	20E
1Y1	2		47	1A1
1Y2	3		46	1A2
GND	4		45	GND
1Y3	5		44	1A3
1Y4	6		43	1A4
V _{CC}	7		42	V _{CC}
2Y1	8		41	2A1
2Y2	9		40	2A2
GND	10		39	GND
2Y3	11		38	2A3
2Y4	12		37	2A4
3Y1	13		36	3A1
3Y2	14		35	3A2
GND	15		34	GND
3Y3	16		33	3A3
3Y4	17		32	3A4
V _{CC}	18		31	V _{CC}
4Y1	19		30	4A1
4Y2	20		29	4A2
GND	21		28	GND
4Y3	22		27	4A3
4Y4	23		26	4A4
4 0E	24		25	30E

IEC Logic Symbol

$10E - 1 \\ 20E - 48 \\ 30E - 25 \\ 40E - 24 \\ 1A1 - 47$	EN1 EN2 EN3 EN4	1		2	- 1Y1
1A2 <u>46</u>		•	• •	3	- 1Y2
1A3 <u>44</u>				5	- 1Y3
1A3 - 43				6	- 1Y4
2A1 <u>41</u>		1	2	8	- 2Y1
2A2 40			2 V	9	- 2Y2
2A2 2A3 <u>38</u>				11	- 2Y3
2A3 2A4 <u>37</u>				12	- 213 - 2Y4
3A1 <u>36</u>		1	3▽	13	
35		I	30	14	- 3Y1
$3A2 - \frac{33}{33}$				16	- 3Y2
3A3 - 22				17	- 3Y3
3A4		4	4	19	- 3Y4
4A I		1	4▽	20	- 4Y1
4AZ				22	- 4Y2
4A3	·			23	- 4Y3
4A4 <u>20</u>					- 4Y4

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Truth Table

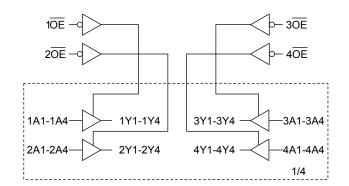
Inp	Outputs			
10E	1A1-1A4	1Y1-1Y4		
L	L	L		
L	Н	Н		
Н	Х	Z		

Inp	Outputs	
20E	20E 2A1-2A4	
L	L	L
L	н	Н
Н	Х	Z

Inp	Outputs	
30E	3A1-3A4	3Y1-3Y4
L	L	L
L	н	Н
Н	Х	Z

Inp	Outputs	
40E	40E 4A1-4A4	
L	L	L
L	н	н
Н	Х	Z

System Diagram



X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 4.6	V
DC input voltage	V _{IN}	-0.5 to 4.6	V
		-0.5 to 4.6 (Note 2)	
DC output voltage	VOUT	–0.5 to V _{CC} + 0.5	V
		(Note 3)	
Input diode current	I _{IK}	-50	mA
Output diode current	IOK	±50 (Note 4)	mA
DC output current	IOUT	±50	mA
Power dissipation	PD	400	mW
DC V_{CC} /ground current per supply pin	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: OFF state
- Note 3: High or low state. IOUT absolute maximum rating must be observed.
- Note 4: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	1.8 to 3.6	V
Tower supply voltage	VCC	1.2 to 3.6 (Note 2)	v
Input voltage	V _{IN}	–0.3 to 3.6	V
Output voltage	Vout	0 to 3.6 (Note 3)	V
Oulput voltage	V001	0 to V_{CC} (Note 4)	v
		±12 (Note 5)	
Output current	I _{OH} /I _{OL}	±8 (Note 6)	mA
		±4 (Note 7)	
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

- Note 3: OFF state
- Note 4: High or low state
- Note 5: $V_{CC} = 3.0$ to 3.6 V
- Note 6: $V_{CC} = 2.3$ to 2.7 V
- Note 7: $V_{CC} = 1.8 V$
- Note 8: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Note 2: Data retention only

Electrical Characteristics

DC Characteristics (Ta = –40 to 85°C, 2.7 V < V_{CC} \leq 3.6 V)

Characteristics		Symbol	nbol Test Condition			Min	Мах	Unit
		Symbol	Test	Condition	V _{CC} (V)	IVIIII	wax	Unit
Input voltago	H-level	VIH		_	2.7 to 3.6	2.0	_	V
Input voltage	L-level	VIL		_	2.7 to 3.6	_	0.8	v
				I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	_	
	H-level	Vон	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -6 \text{ mA}$	2.7	2.2	_	
		_		$I_{OH} = -8 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -12 \text{ mA}$	3.0	2.2	_	V
			$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 100 μA	2.7 to 3.6	_	0.2	
	L-level	V _{OL}		I _{OL} = 6 mA	2.7	_	0.4	
	L-level			I _{OL} = 8 mA	3.0	_	0.55	
				I _{OL} = 12 mA	3.0	_	0.8	
Input leakage curre	ent	I _{IN}	V _{IN} = 0 to 3.6 V		2.7 to 3.6	_	±5.0	μA
3-state output OFF state current		I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OLIT} = 0 \text{ to } 3.6 \text{ V}$		2.7 to 3.6	_	±10.0	μA
Power-off leakage current		IOFF	V _{IN} , V _{OUT} = 0 to 3.6 V		0	_	10.0	μA
			$V_{IN} = V_{CC}$ or GND		2.7 to 3.6		20.0	
Quiescent supply current		I _{CC} V	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		2.7 to 3.6		±20.0	μA
Increase in I _{CC} pe	r input	∆l _{CC}	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6		750	

DC Characteristics (Ta = -40 to 85°C, 2.3 V \leq V_{CC} \leq 2.7 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	H-level	VIH	-	_	2.3 to 2.7	1.6	_	V
Input voltage	L-level	V _{IL}		_	2.3 to 2.7	_	0.7	v
				I _{OH} = -100 μA	2.3 to 2.7	V _{CC} - 0.2	_	
	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -4 \text{ mA}$	2.3	2.0		
				$I_{OH} = -6 \text{ mA}$	2.3	1.8	_	
Output voltage				$I_{OH} = -8 \text{ mA}$	2.3	1.7	_	
			V_{OL} $V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 100 μA	2.3 to 2.7	_	0.2	
	L-level	V _{OL}		$I_{OL} = 6 \text{ mA}$	2.3	_	0.4	
				I _{OL} = 8 mA	2.3	_	0.6	
Input leakage curre	ent	I _{IN}	V _{IN} = 0 to 3.6 V		2.3 to 2.7	_	±5.0	μA
	atata aurrant	1	$V_{IN} = V_{IH} \text{ or } V_{IL}$		2.3 to 2.7	_	±10.0	
3-state output OFF state current		loz	V _{OUT} = 0 to 3.6 V		2.3 10 2.7		±10.0	μA
Power-off leakage	current	IOFF	V_{IN} , $V_{OUT} = 0$ to 3.6 V		0		10.0	μA
Quiescent supply of		loo	$V_{IN} = V_{CC}$ or GND		2.3 to 2.7		20.0	μA
Quiescent supply (Icc	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		2.3 to 2.7		±20.0	μA

DC Characteristics (Ta = -40 to 85°C, 1.8 V \leq V_{CC} < 2.3 V)

Characteristics		Symbol	Test Condition			Min	Мах	Unit
		Symbol			$V_{CC}(V)$	IVIIII	wax	
Input voltage	H-level	VIH		—	1.8 to 2.3	$0.7 \times V_{CC}$	_	V
input voltage	L-level	V _{IL}	_		1.8 to 2.3		$0.2 \times V_{CC}$	v
H-level	H-level	V _{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OH} = -100 μA	1.8	V _{CC} - 0.2	_	v
				I _{OH} = -4 mA	1.8	1.4		
	L-level	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100 \ \mu A$	1.8		0.2	
	L-IEVEI			$I_{OL} = 4 \text{ mA}$	1.8		0.3	
Input leakage curren	nt	I _{IN}	V _{IN} = 0 to 3.6 V		1.8		±5.0	μA
3-state output OFF state current		I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		1.8		±10.0	μΑ
Power-off leakage current		I _{OFF}	V _{IN} , V _{OUT} = 0 to 3.6 V		0		10.0	μA
		1	V _{IN} = V _{CC} or GND		1.8	_	— 20.0	
Quiescent supply cu	urrent	Icc	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		1.8	_	±20.0	μA

AC Characteristics (Ta = -40 to 85°C, input: $t_r = t_f = 2.0 \text{ ns}$, $C_L = 30 \text{ pF}$, $R_L = 500 \Omega$) (Note 1)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
	4		1.8	1.5	5.7	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	1.0	3.8	ns
	t _{pHL}		$\textbf{3.3}\pm\textbf{0.3}$	0.8	3.3	
3-state output enable time	4		1.8	1.5	6.7	
	t _{pZL} t _{pZH}	Figure 1, Figure 3	2.5 ± 0.2	1.0	5.1	ns
			$\textbf{3.3}\pm\textbf{0.3}$	0.8	3.8	
	•		1.8	1.5	5.0	
3-state output disable time	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	2.5 ± 0.2	1.0	4.0	ns
			$\textbf{3.3}\pm\textbf{0.3}$	0.8	3.6	
	4		1.8		0.5	
Output to output skew	t _{osLH} t _{osHL}	(Note 2)	2.5 ± 0.2	_	0.5	ns
			$\textbf{3.3}\pm\textbf{0.3}$	_	0.5	

Note 1: For $C_L = 50 \text{ pF}$, add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design. $(t_{osLH} = |t_{pLHm} - t_{pLHn}|, \ t_{sHL} = |t_{pHLm} - t_{pHLn}|)$

Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.0 \text{ ns}$, $C_L = 30 \text{ pF}$)

Characteristics	Symbol	Test Condition		Тур.	Unit	
		Test Condition				$V_{CC}\left(V\right)$
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 1.8 V, V_{IL} = 0 V$	(Note)	1.8	0.15	
		$V_{IH} = 2.5 V, V_{IL} = 0 V$	(Note)	2.5	0.25	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	3.3	0.35	
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 1.8 V, V_{IL} = 0 V$	(Note)	1.8	-0.15	V
		$V_{IH} = 2.5 V, V_{IL} = 0 V$	(Note)	2.5	-0.25	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	3.3	-0.35	
Quiet output minimum dynamic V _{OH}	V _{OHV}	$V_{IH} = 1.8 V, V_{IL} = 0 V$	(Note)	1.8	1.55	
		$V_{IH} = 2.5 V, V_{IL} = 0 V$	(Note)	2.5	2.05	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	3.3	2.65	

Note: Parameter guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		Тур.	Unit
Characteristics	Symbol	rest condition	V _{CC} (V)		
Input capacitance	C _{IN}	_	1.8, 2.5, 3.3	6	pF
Output capacitance	CO	_	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note	1.8, 2.5, 3.3	20	pF

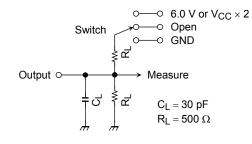
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16$ (per bit)

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AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
t _{pLZ} , t _{pZL}			
t _{pHZ} , t _{pZH}	GND		



AC Waveform

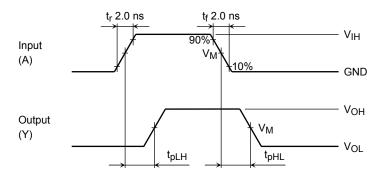


Figure 2 t_{pLH}, t_{pHL}

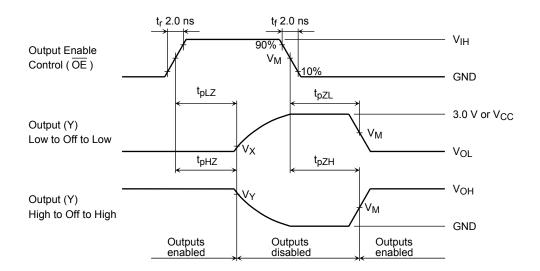


Figure 3 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$

Symbol	V _{CC}				
Symbol	$3.3\pm0.3~V$	$2.5\pm0.2~V$	1.8 V		
VIH	2.7 V	V _{CC}	V _{CC}		
VM	1.5 V	V _{CC} /2	V _{CC} /2		
VX	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V		
VY	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V		

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Unit: mm

Package Dimensions

TSSOP48-P-0061-0.50A

48 6.1±0.1 8.1±0.2 24 $0.2^{+0.07}_{-0.06}$ 0.5 0.5TYP **⊕**0.1M 12.8MAX 12.5 ± 0.1 1.2MAX ᠳᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣᠣ 1.0 ± 0.05 0.1±0.05 $0.125_{-0.01}^{+0.03}$ 0~10° 0.25 (0.5) 0.45~0.75

Weight: 0.25 g (typ.)

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20070701-EN GENERAL

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